

SLOVENSKI STANDARD SIST EN 62431:2009

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Merilne metode za odbojnost absorberjev milimetrskih elektromagnetnih valov (IEC 62431:2008)

Reflectivity of electromagnetic wave absorbers in millimetre wave frequency - Measurement methods (IEC 62431:2008)

Verfahren zur Messung des Reflexionsvermögens von Absorbern für elektromagnetische Wellen im Millimeterwellen-Frequenzbereich (IEC 62431 2008)

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Réflectivité des absorbeurs d'ondes électromagnétiques dans la plage des fréquences millimétriques - Méthodes de mesure (CEI-62431:2008)

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EUROPEAN STANDARD

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Reflectivity of electromagnetic wave absorbers in millimetre wave frequency Measurement methods

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Réflectivité des absorbeurs d'ondes électromagnétiques dans la plage des fréquences millimétriques -Méthodes de mesure (CEI 62431:2008) Verfahren zur Messung des Reflexionsvermögens von Absorbern für elektromagnetische Wellen im Millimeterwellen-Frequenzbereich (IEC 62431:2008)

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This European Standard was approved by CENELEC on 2008-11-01. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration 1 2009

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Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the Central Secretariat or to any CENELEC member.

This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the Central Secretariat has the same status as the official versions.

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European Committee for Electrotechnical Standardization Comité Européen de Normalisation Electrotechnique Europäisches Komitee für Elektrotechnische Normung

Central Secretariat: rue de Stassart 35, B - 1050 Brussels

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Foreword

The text of document 46F/65/CDV, future edition 1 of IEC 62431, prepared by SC 46F, R.F. and microwave passive components, of IEC TC 46, Cables, wires, waveguides, R.F. connectors, R.F. and microwave passive components and accessories, was submitted to the IEC-CENELEC Parallel Unique Acceptance Procedure and was approved by CENELEC as EN 62431 on 2008-11-01.

The following dates were fixed:

 latest date by which the EN has to be implemented at national level by publication of an identical national standard or by endorsement

(dop) 2009-08-01

 latest date by which the national standards conflicting with the EN have to be withdrawn

(dow) 2011-11-01

Annex ZA has been added by CENELEC.

Endorsement notice

The text of the International Standard IEC 62431:2008 was approved by CENELEC as a European Standard without any modification.

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Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	EN/HD	<u>Year</u>
ISO/IEC 17025	- ¹⁾	General requirements for the competence of testing and calibration laboratories	EN ISO/IEC 17025	2005 2)

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¹⁾ Undated reference.

²⁾ Valid edition at date of issue.

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Reflectivity of electromagnetic wave absorbers in millimetre wave frequency – Measurement methods (standards.iteh.ai)

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

REFLECTIVITY OF ELECTROMAGNETIC WAVE ABSORBERS IN MILLIMETRE WAVE FREQUENCY – MEASUREMENT METHODS

FOREWORD

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International Standard IEC 62431 has been prepared by subcommittee SC46F: RF and microwave passive components, of IEC technical committee 46: Cables, wires, waveguides, R.F. connectors, R.F. and microwave passive components and accessories.

IEC 62431 replaces and cancels IEC/PAS 62431 with corrections of obvious errors as noted in 46F/29A/RVN.

The text of this standard is based on the following documents:

CDV	Report on voting
46F/65/CDV	46F/72/RVC

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

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The committee has decided that the contents of this publication will remain unchanged until the maintenance result date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

- · reconfirmed,
- withdrawn,
- · replaced by a revised edition, or
- · amended.

A bilingual version of this publication may be issued at a later date.

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REFLECTIVITY OF ELECTROMAGNETIC WAVE ABSORBERS IN MILLIMETRE WAVE FREQUENCY – MEASUREMENT METHODS

1 Scope

This International Standard specifies the measurement methods for the reflectivity of electromagnetic wave absorbers (EMA) for the normal incident, oblique incident and each polarized wave in the millimetre-wave range. In addition, these methods are also equally effective for the reflectivity measurement of other materials:

- measurement frequency range: 30 GHz to 300 GHz;
- reflectivity: 0 dB to -50 dB;
- incident angle: 0° to 80°.

NOTE This standard is applicable not only to those EMA which are widely used as counter-measures against communication faults, radio interference etc., but also to those used in an anechoic chamber in some cases. EMAs may be any kind of material, and may have any arbitrary shape, configuration, or layered structure as pointed out below.

Material: Conductive material, dielectric material, magnetic material.

Shape: planar-, pyramidal-, wedge-type, or other specific shapes. PREVIEW

Layer structure: single layer, multi layers or graded index material. h.ai)

2 Normative references

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The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO/IEC 17025, General requirements for the competence of testing and calibration laboratories

3 Terms, definitions and acronyms

For the purposes of this document, the following terms and definitions apply.

3.1 Terms and definitions

3.1.1

ambient level

the value of radiation power or noise which exists when no measurement is being carried out at the experiment site

3.1.2

associated equipment

an apparatus or product connected for convenience or operation of the equipment

3.1.3

beam diameter

the diameter where the electric field strength decreases by 3 dB from the centre of the focused beam

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3.1.4

beam waist

the portion at which the diameter of the focused beam becomes minimum when the electromagnetic waves radiated from a transmit antenna are converged using a dielectric lens

3.1.5

beam waist diameter

beam diameter at the beam waist

3.1.6

bistatic measurement

measurement where the incident and reflection angle are equal

3.1.7

dielectric lens

electromagnetic wave lens that is composed of dielectric material

Usually, it is used by mounting in front of a pyramidal or conical horn.

3.1.8

directional gain

ratio of the radiated power density in a particular direction to the average power density that would be radiated in all directions

3.1.9 iTeh STANDARD PREVIEW

dynamic range

difference in decibels between the receiving level from the reference metal plate and the receiving level measured when the metal plate is removed

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electromagnetic wave absorber ff7065009ea9/sist-en-62431-2009

material ingredient which absorbs the electromagnetic wave energy and dissipates it thermally

3.1.11

focal distance

distance between the centre of the dielectric lens and the focal point

3.1.12

focal point

centre of the beam waist when the electromagnetic waves are converged using a dielectric lens

3.1.13

focused beam

focused electromagnetic wave converged by the dielectric lens mounted in front of the horn antenna

The focused beam diameter is a few times the wavelength or more at the beam waist, which depends on the focal distance of the lens.

3.1.14

fraunhofer region

region where the angular radiation pattern of an aperture antenna is nearly independent of the distance

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3.1.15

free-space method

measurement method that employs a single or pair of horn antennas where the specimen and the antennas are put in free space

3.1.16

fresnel region

region where the angular radiation pattern of an aperture antenna depends on the distance except for the region extremely near to the aperture

3.1.17

horn antenna

aperture antenna where impedance matching is taken gradually from the waveguide aperture to free space

3.1.18

monostatic measurement

measurement where the incident and reflected waves follow the same direction and which lie at an arbitrary angle with respect to normal to the specimen surface

3.1.19

normal incidence

the incidence for which an electromagnetic wave strikes to the specimen surface normally

The reflectivity in normal incidence is usually measured in the configuration where the incident angle of a transmitting antenna and that of a receiving antenna are within 0° to 5° with respect to the normal direction of the specimen surface.

3.1.20

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oblique incidence https://standards.iteh.ai/catalog/standards/sist/9bf01460-e257-4f59-aa2c-

the incidence for which an electromagnetic wave strikes to the specimen surface at an oblique angle

The reflectivity in oblique incidence is usually measured with a transmitting and receiving antenna set up so that the incident and reflected angle of EM wave may be equal.

3.1.21

parallel beam

EM wave, which has a nearly flat phase front on the surface normal to the antenna axis, and which is formed using a dielectric lens set-up in front of a horn antenna

3.1.22

reference metal plate

metal plate with the same shape and an equal surface projected area in normal to the specimen

3.1.23

reflectivity

the ratio between reflected EM wave voltage received by the receiving antenna when a specimen is irradiated by the EM wave, and the voltage of the EM wave reflected from a metal plate with equal size and with the same projection shape in normal to the specimen surface expressed in decibel by

reflectivity =
$$20\log_{10} \left| \frac{V_S}{V_m} \right| = 20\log_{10} |V_S| - 20\log_{10} |V_m| \text{ [dB]}$$
 (1)

where $V_{\rm s}$ is the reflected EM wave voltage received by the receiving antenna when a specimen is irradiated by the EM wave, and $V_{\rm m}$ is the voltage of the EM wave reflected from a